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STATEMENT BY APPLICANT**  
( Not for submission under 37 CFR 1.99)

Application Number	10800409
Filing Date	2004-03-11
First Named Inventor	Wu et al.
Art Unit	1762
Examiner Name	Chen, B.
Attorney Docket Number	NOVLP098/NVLS-2907

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/BC/	5	20060040507		2006-02-23	Mak et al.	
	6	20050230834		2005-10-20	Schmitt et al.	
	7	20060105566		2006-05-18	Waldfried et al.	
	8	20040018717		2004-01-29	Fornof et al.	
	9	20040213911		2004-10-28	Misawa et al.	
	10	20040249006		2004-12-09	Gleason et al.	
	11	20050095840		2005-05-05	Bhanap et al.	
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	2	U.S. Office Action mailed March 28, 2007, from U.S Application No. 10/820,525 [Atty Dkt No. NOVLP091/NVLS-2889]	<input type="checkbox"/>
	3	U.S. Office Action mailed January 24, 2007, from U.S Application No. 10/789,103 [Atty Dkt No. NOVLP094/NVLS-2919]	<input type="checkbox"/>
	4	U.S. Office Action mailed June 21, 2007, from U.S Application No. 10/789,103 [Atty Dkt No. NOVLP094/NVLS-2919]	<input type="checkbox"/>
	5	Niu et al., "Methods for Improving the Cracking Resistance of Low-K Dielectric Materials," Novellus Systems, Inc., Appl. No. 11/376,510, filed March 14, 2006, pages 1-28. [NOVLP099D1/NVLS-2896D1]	<input type="checkbox"/>
	6	U.S. Office Action dated May 22, 2007, from U.S. Application No. 11/376,510 [Atty Dkt: NOVLP099D1/NVLS-2896D1]	<input type="checkbox"/>
	7	U.S. Notice of Allowance and Fee Due mailed April 9, 2007, from U.S. Application No. 10/927,777. [NOVLP106/NVLS-2930]	<input type="checkbox"/>
	8	Allowed Claims from U.S. Application No. 10/927,777. [NOVLP106/NVLS-2930]	<input type="checkbox"/>
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/BC/	10	U.S. Notice of Allowance and Fee Due mailed December 20, 2005, from U.S. Application No. 10/860,340. [NOVLP099/NVLS-2896]	<input type="checkbox"/>
	11	Wu et al., "PECVD Methods for Producing Ultra Low-K Dielectric Films Using UV Treatment," Novellus Systems, Inc., Appl. No. 11/608,056, filed December 7, 2006, pages 1-34. [NOVLP196/NVLS-3238]	<input type="checkbox"/>
/BC/	12	Wu et al., "Methods for Improving Performance of ODC Films with Dielectric Constant < 4.0," Novellus Systems, Inc., Appl. No. 11/693,661, filed March 29, 2007, pages 1-46. [NOVLP200/NVLS-3269]	<input type="checkbox"/>

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